**TIN-CLAD COPPER FOILS TAPES**

- **PPI 9510**
  - Tin clad copper shielding tape with non-conductive adhesive

- **PPI 9515**
  - Tin clad copper shielding tape with electrically conductive adhesive

- **PPI 9516**
  - Double sided tin clad copper on both sides with electrically conductive adhesive

- **RD-445 0.035mm**
  - Thicker layer of adhesive giving increased adhesive strength

- **RD-715-6 0.035mm**
  - Low out-gassing version
  - Suited to aerospace and hard disk applications

- **PPI 9520 0.035mm**
  - Embossed version of 9510
**PPI 9510**

tin clad copper shielding tape with non-conductive adhesive

based on copper foil tin clad on both sides. The tin layers provide improved solderability and corrosion resistance.

**Application:**
- EMI/RFI shielding
- electrical grounding
- static charge draining
- cable and connector shielding

**PPI 9515**

tin clad copper shielding tape with electrically conductive adhesive

based on copper foil tin clad on both sides. The adhesive is electrically conductive, thus ensuring secure shielding continuity. The tin layers provide improved solderability and corrosion resistance.

**Application:**
- EMI/RFI shielding
- electrical grounding
- static charge draining
- cable and connector shielding

**RD-445**

tin clad copper shielding tape with electrically conductive adhesive

based on copper foil tin clad on both sides. The adhesive is electrically conductive, thus ensuring secure shielding continuity. The tin layers provide improved solderability and corrosion resistance.

**Application:**
- EMI/RFI shielding
- electrical grounding
- static charge draining
- cable and connector shielding

**PPI 9516**

tin-clad copper shielding tape coated both sides with electrically conductive adhesive

based on copper foil tin clad on both sides. The adhesive is electrically conductive, thus ensuring secure shielding continuity. The tin layers provide improved solderability and corrosion resistance.

**Application:**
- EMI/RFI shielding
- electrical grounding
- static charge draining
- cable and connector shielding

**RD-715-6**

tin clad copper adhesive tape with a low outgassing conductive polyacrylate adhesive

based on a tin-clad copper foil coated with a low-outgassing, electrically conductive acrylic adhesive. The adhesive has been specially formulated to be thoroughly crosslinked and also low outgassing.

**Application:**
- conductive contacting tape suitable for aerospace and hard disk applications

**PPI 9520**

embossed tin-clad copper shielding tape

based on copper foil tin-clad on both sides. The tape has an embossed pattern that provides direct contact through the adhesive. The tin layers provide improved solderability and corrosion resistance.

**Application:**
- EMI/RFI shielding
- electrical grounding
- static charge draining
- cable and connector shielding